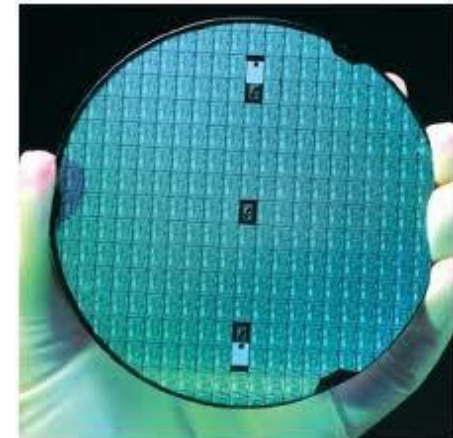
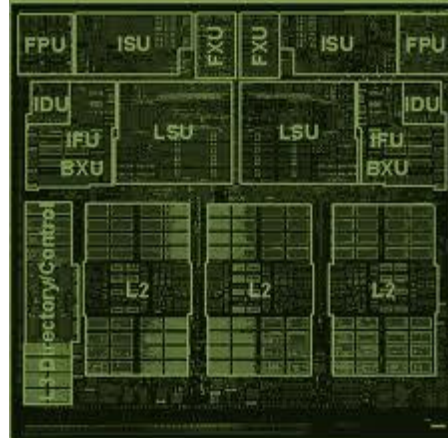
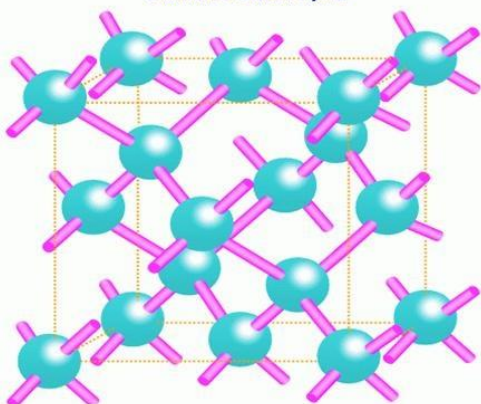


Structure of silicon crystal



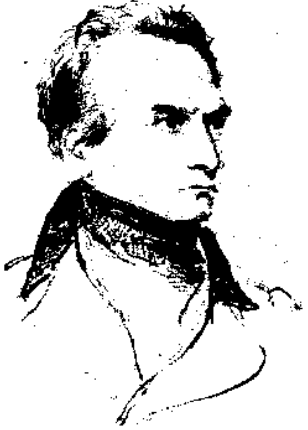
ECE 122A

VLSI Principles

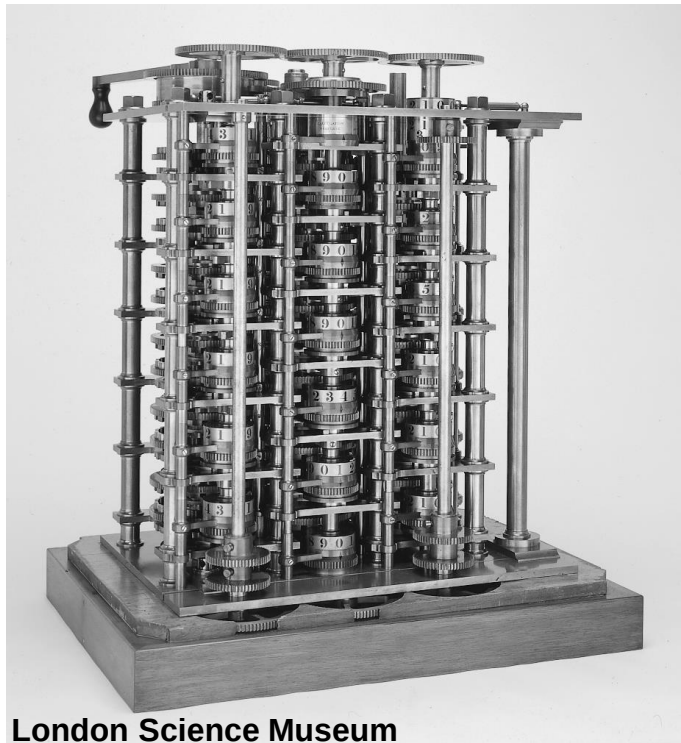
Lecture 2

Prof. Kaustav Banerjee
Electrical and Computer Engineering
University of California, Santa Barbara
E-mail: kaustav@ece.ucsb.edu

History of Computing.....The first computer



Charles Babbage
(1791-1871)



London Science Museum

The Babbage Difference Engine (1832)

25,000 parts

cost: £17,470

**A mechanical digital
calculator...**

Mechanical computing devices

Used decimal number system

Could perform basic arithmetic
operations

Even store and execute

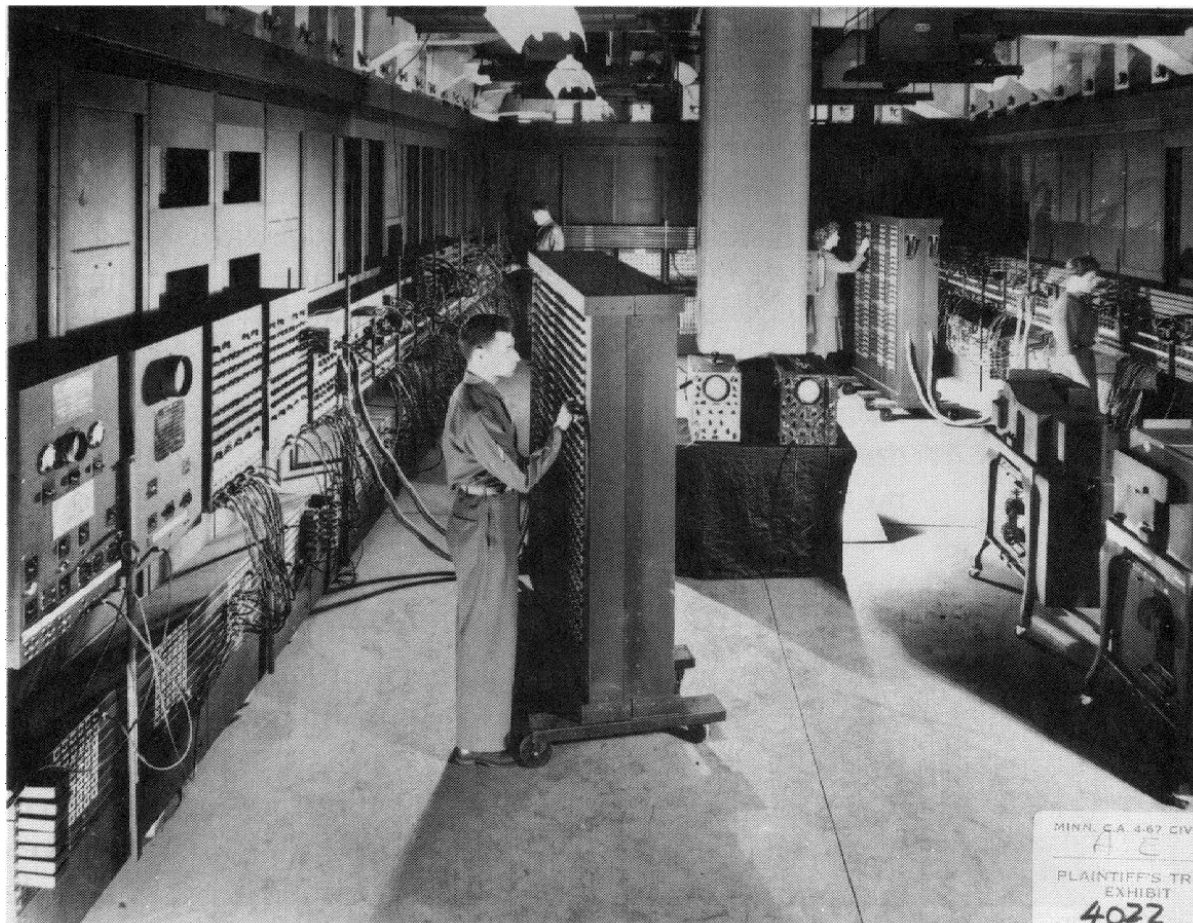
Problem: Too complex and expensive!

Further Reading....

- ❑ http://en.wikipedia.org/wiki/Difference_engine
- ❑ *How Computers Do Math*

(ISBN: 0471732788) Wiley, Clive Maxfield and Alvin Brown.

ENIAC - The first electronic computer (1946)



*Vacuum tube
based
computer...*

*For Military
applications...*

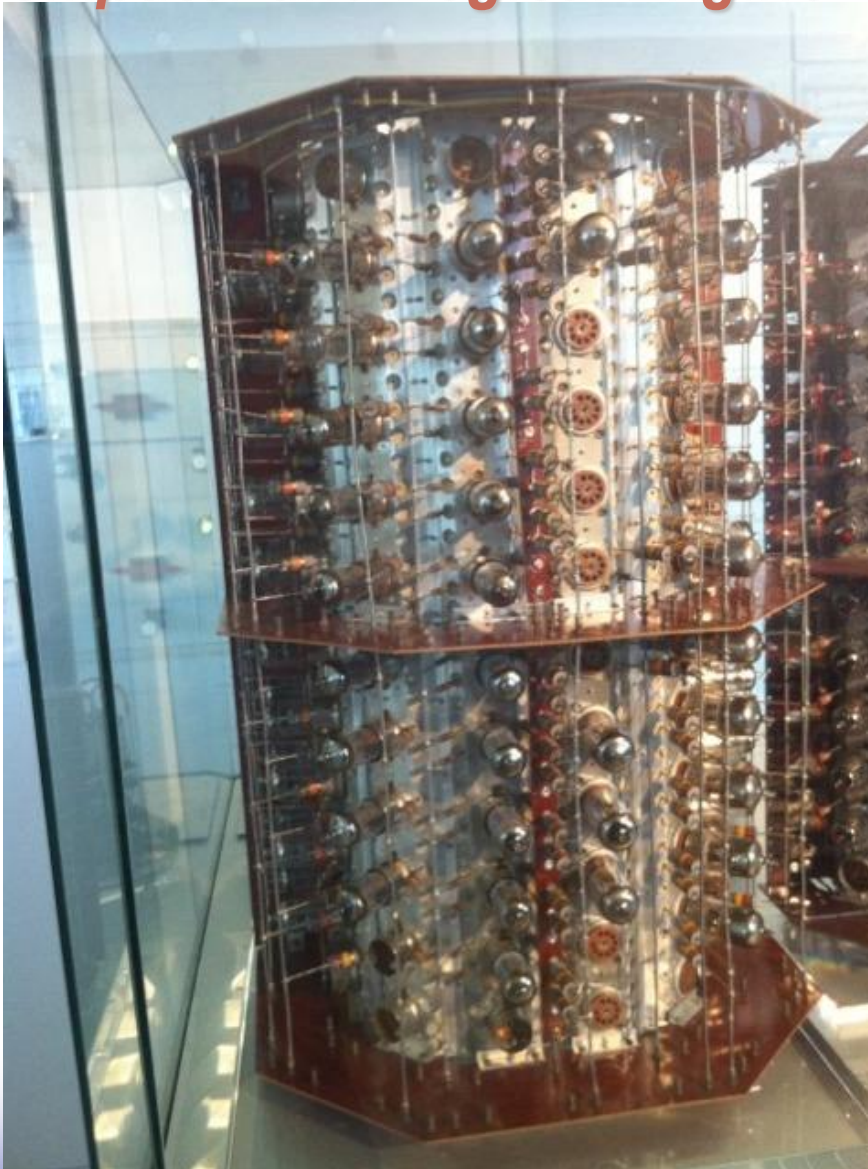
*80 ft long, 8.5 ft
high, several ft
wide...*

*With ~18,000
vacuum tubes!*

Problem: Reliability issues and excessive power consumption!

4

Parts of the ORACLE Computer –Oak Ridge Automatic Computer and Logical Engine---Oak Ridge National Lab (1950-54)



Used vacuum tubes, transistors, and diodes.

Addition time: 70 microseconds

Multiplication time: 370-590 microseconds

Division time: 590 microseconds

These times include the storage access time, which was about 62 microseconds.

Credit: Deutsches Museum, Munich, Germany

The Transistor Revolution...

http://www.nobelprize.org/educational/physics/integrated_circuit/history/

The first point contact transistor

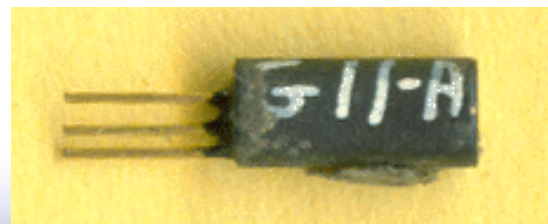
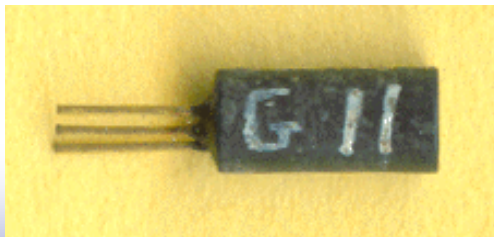
William Shockley, John Bardeen, and Walter Brattain
Bell Laboratories, Murray Hill, New Jersey (1947)



First transistor
Bell Labs, 1947
(Ge point contact-
Bipolar transistor)
Bardeen and
Brattian
-Nobel Laureates

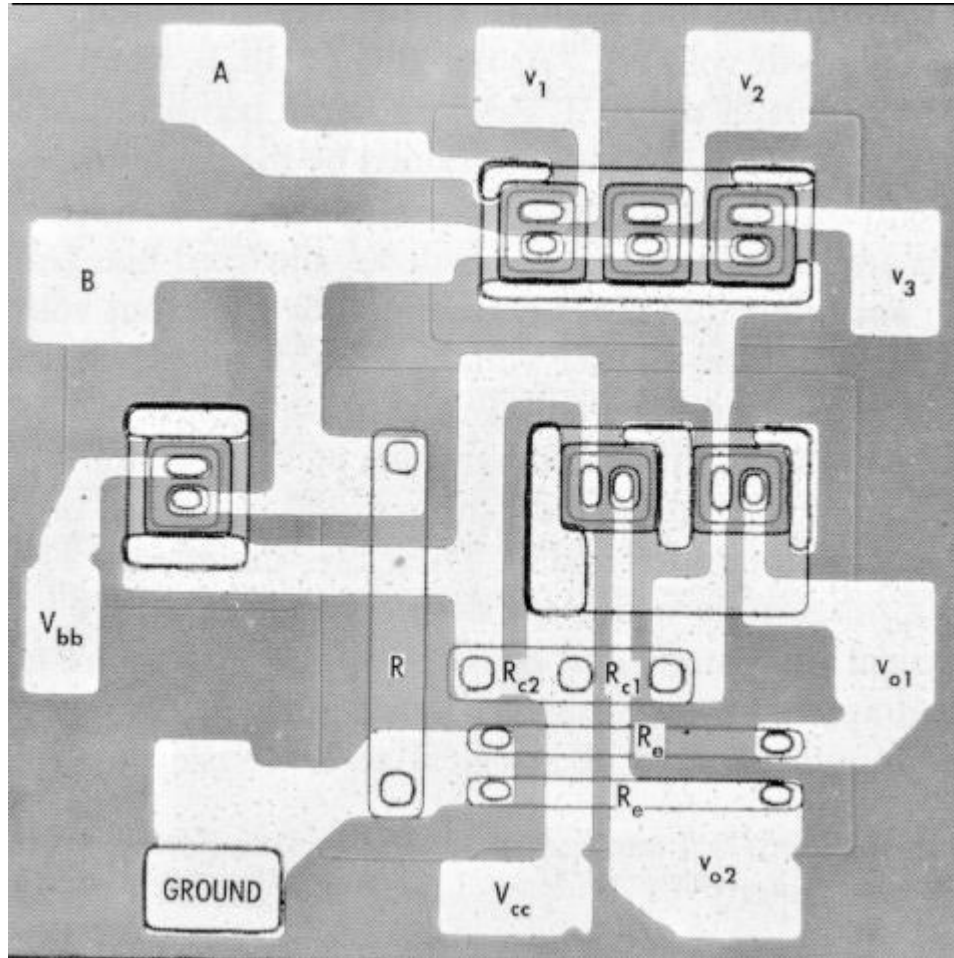
BJT (1948)
Schockley
— Nobel Laureate

General Electric types G11 and G11A commercial point contact transistors



Transistor Size (1/8" OD X 3/8")

The First Integrated Circuits



ECL 3-input Gate
Motorola 1966

Jack Kilby, Texas Instruments (1958), the first integrated circuit, (Ge based) or microchip (patent #3,138,743), **Nobel Prize in 2000**



Robert Noyce (1927-1990), **co-founder of Fairchild and Intel**, the first monolithic integrated circuit, (U.S. Patent 2,981,877 July 1959). Si based with Cu interconnects, more practical than Kilby's IC.

Bipolar logic – built with BJTs

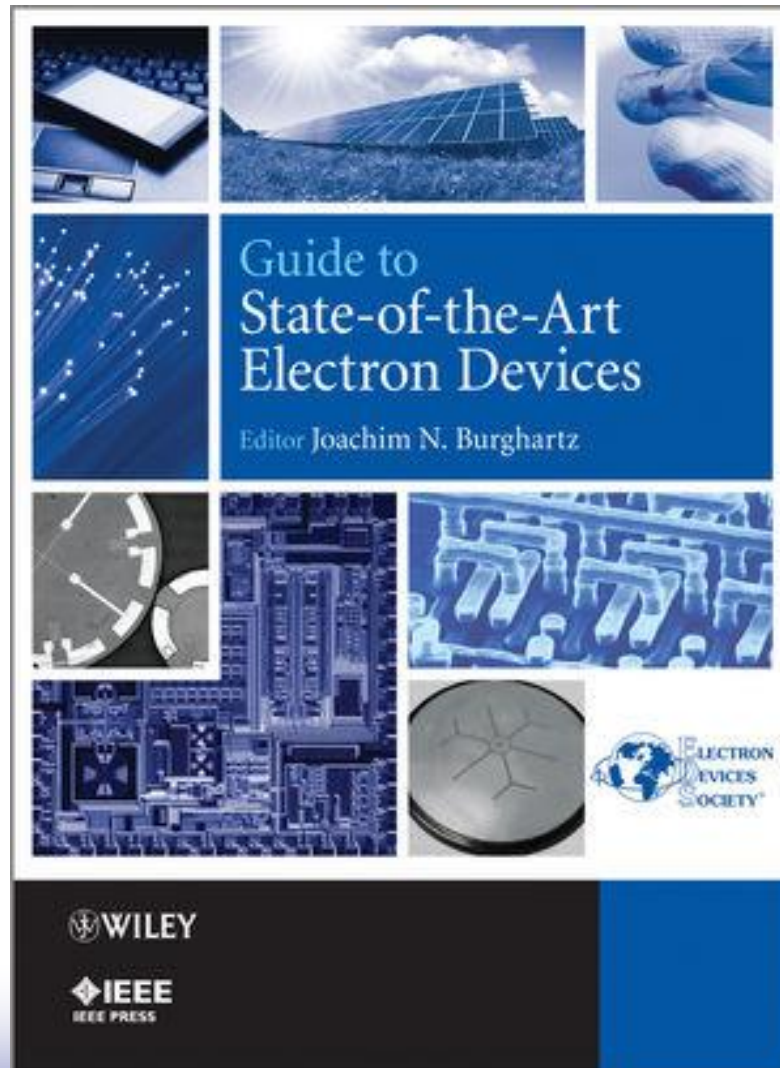
Early 1960's (TTL, ECL)

TTLs offered higher integration density—composed largest fraction of semiconductor market until the 1980s

Integrated Circuits (Early) History

- ❑ Invention of BJT (1948)
- ❑ First silicon transistor (1954)
- ❑ MOS transistor (1960)
- ❑ MOS integrated circuit (1962)
- ❑ DRAM cell (1968)
- ❑ Intel formed (1968) (Intel: short form of integrated electronics)
- ❑ AMD formed (1969)
- ❑ Microprocessor invented (1971)
- ❑ 32-bit microprocessors (1980)

For more historical perspectives....



Chapter 11

VLSI Technology and Circuits

by K. Banerjee and S. Ikeda

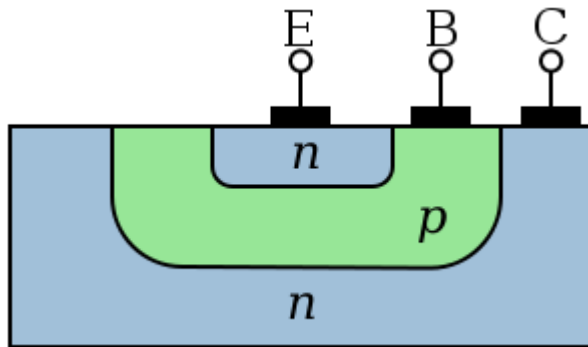
BJT vs FETs

Both are based on basic properties of pn junctions

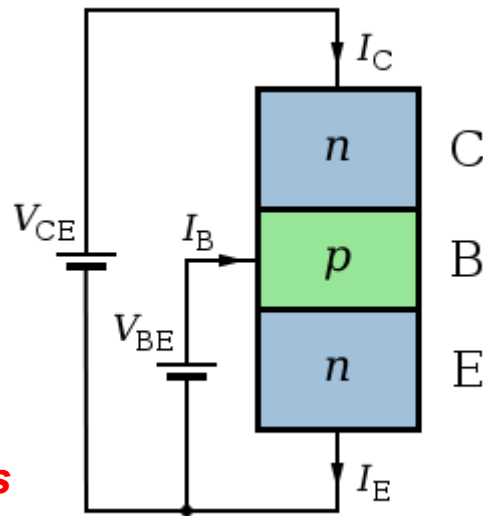
- ❑ A Bipolar Junction Transistor (BJT) is a 3 terminal device
- ❑ Uses the injection of minority carriers (under a forward bias)
- ❑ A BJT is a “bipolar” device (both electrons and holes are involved in its operation)
- ❑ It is an asymmetric device....why?
- ❑ A Field Effect Transistor (FET) is also a 3 terminal device (plus a substrate terminal)
- ❑ A FET is a “unipolar” device (majority carrier only)
- ❑ It is based on controlling the depletion width of a--- junction (JFET) or a Schottky Barrier (MESFET) through a control (gate) voltage

Power has been the main driver for various technologies.....vacuum tubes, BJT, PMOS, NMOS, CMOS.....???

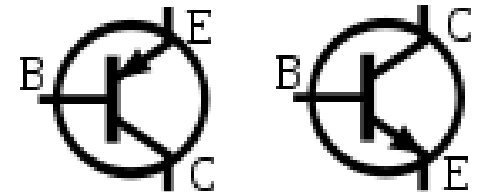
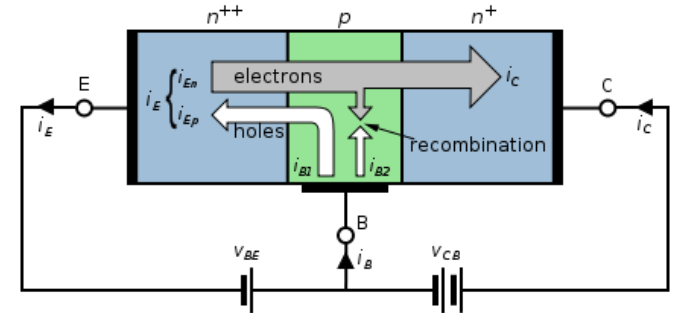
Recalling the BJT.....



Schematic cross-sectional view of a planar NPN bipolar junction transistor...emitter is more heavily doped than collector....depth of “p” region must be smaller than the diffusion length of electrons



Basic structure of an NPN BJT



Schematic symbols for PNP and NPN type BJTs

- Both **electrons and holes** are involved in the operation.....hence the name “**bipolar**”
- For NPN BJT: electrons are injected from a high-concentration emitter (n^{++}) into the p-type base.....where they are **minority carriers** that diffuse toward the collector (n^{+}).....hence BJTs are **minority-carrier** devices
- **Quiescent power** (drawn even in idle circuits) due to small base current limits large-scale integration

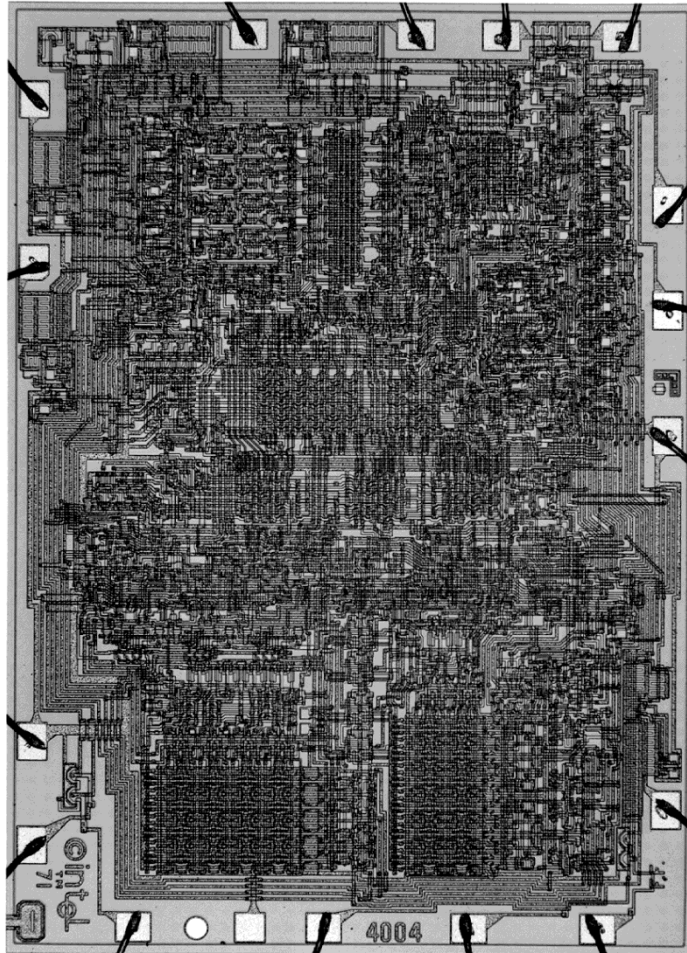
Other FETs.....

- ❑ If the metal gate electrode is separated from the semiconductor by an insulator— **metal-insulator-semiconductor FET (MISFET)**
- ❑ Also called an **IGFET** (insulated gateFET)
- ❑ Most commonly called as **MOSFET** (**metal-oxide-semiconductor FET**)
- ❑ FETs have **high input impedance**—since the control voltage is applied to a reverse biased junction or Schottky Barrier or across an insulator-----they are better suited (than BJTs) for controlled switching between conducting (ON) and non-conducting (OFF) states---therefore better for digital circuit implementation....**low-power**
- ❑ FETs are also more integrable...processing perspective

Strange History of FETs.....

- ❑ Actually FET was invented (proposed) in 1925!! (by Julius Lilienfeld)
- ❑ But.....it never worked....Why?.....
 - Role of **surface defects**....dangling bonds etc. causing large number of surface states....Fermi level pinning
 - **Silicon dioxide**....a **key material** for Silicon's success.....
- ❑ **Bardeen and Brattain** accidentally discovered the first (bipolar) transistor: the Ge point contact transistor---- while trying to experimentally demonstrate the FET
- ❑ **First MOSFET** demonstrated in 1960 by **Kahng and Atalla** at Bell Labs
- ❑ **First logic gates using MOSFETs** (both n-type and p-type...thus Complementary-MOS-FET)— **Frank Wanlass and C. T. Sah** at Fairchild in 1963

Intel 4004 Micro-Processor



Nov 1971

~2300 transistors

Max. CPU Clk rate: 750 KHz

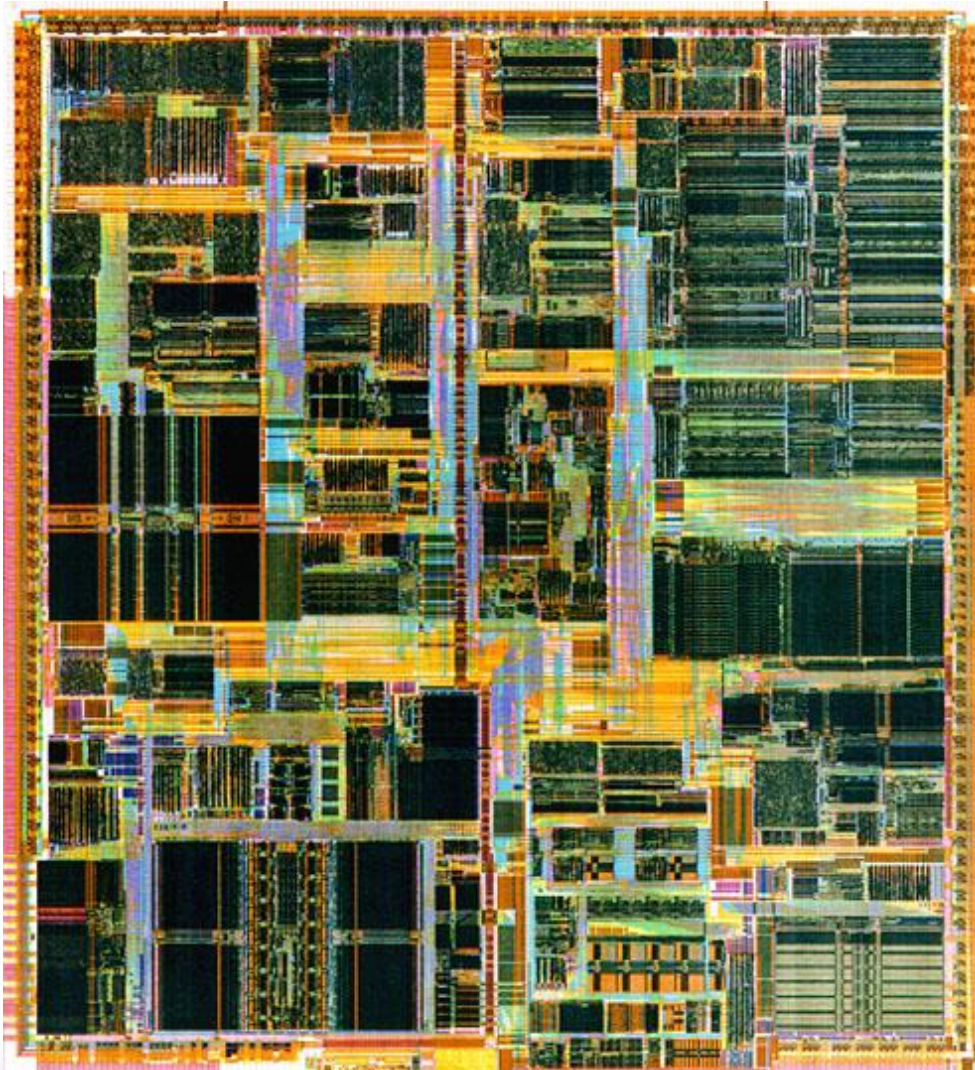
PMOS only (10 μ m process)

Note: *although NMOS was conceived in the early 1960s—application in wrist watches and portable electronics (of 1960s)---but device quality was poor, hence PMOS was used until 1974*

The 1971 4004 Microprocessor (10 μ m process) was PMOS only

---Intel 8080 (8-bit) Microprocessor (1974)
6 thousand transistors, 2 MHz
NMOS only (6 μ m process)

Intel Pentium (IV) Microprocessor



2003:
CMOS based
> 50 million transistors
> 3GHz operation

Economic Implications

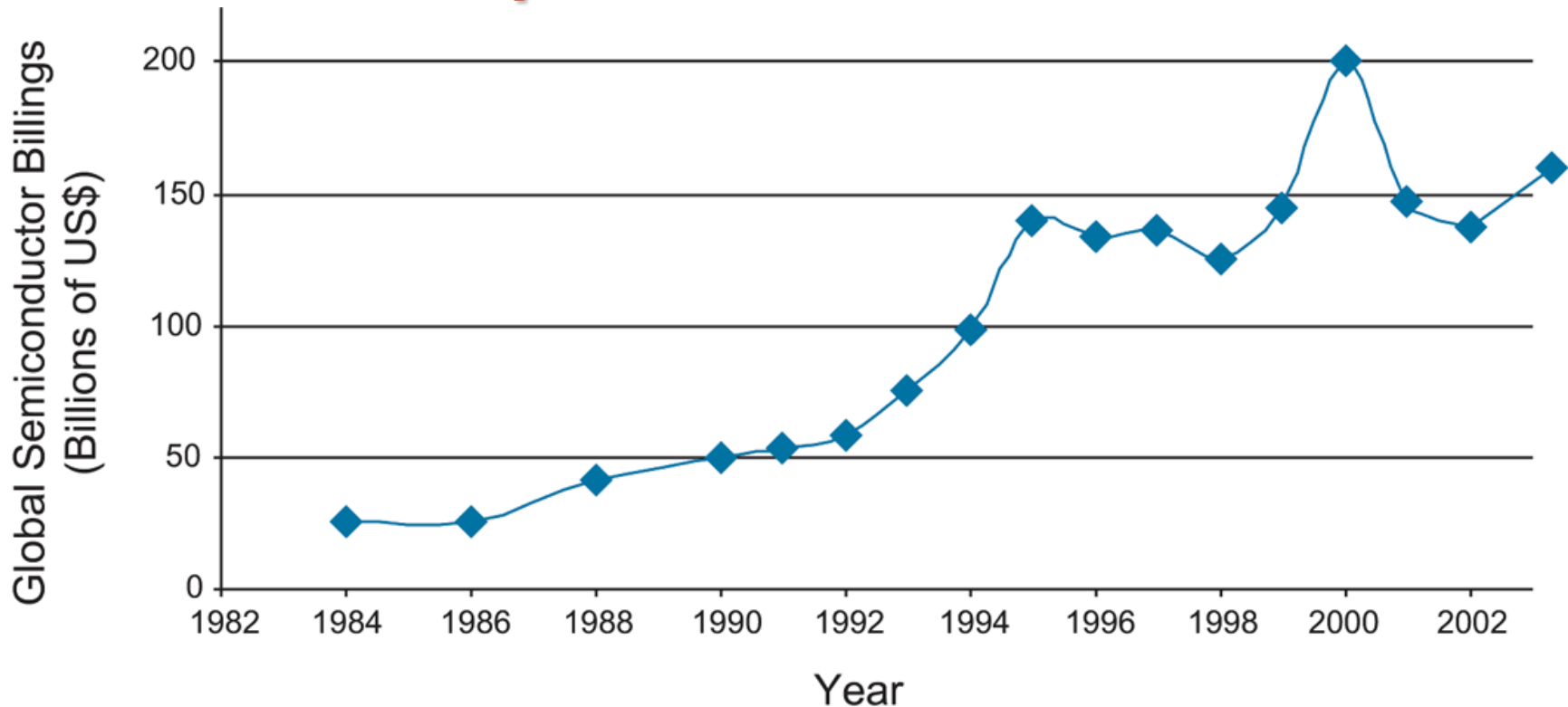


FIG 1.1 Size of worldwide semiconductor market

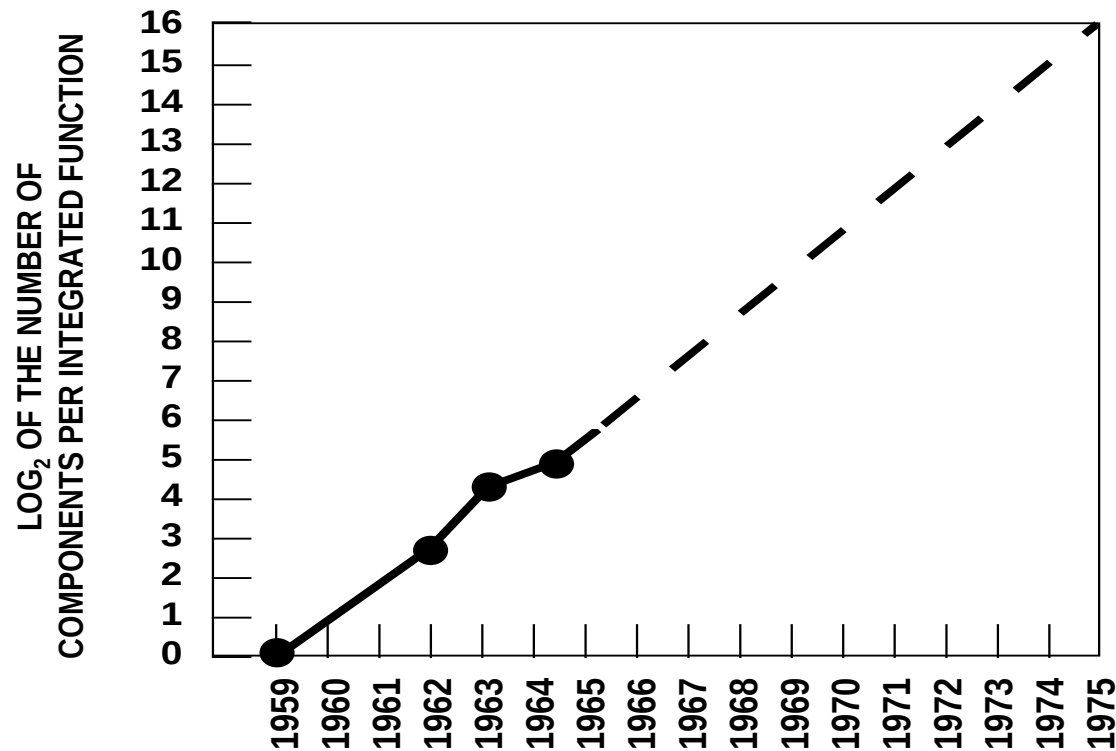
Source: Semiconductor Industry Association.

For more up to date info. go to the **International Technology Roadmap for semiconductors (ITRS)** <http://public.itrs.net/>

Moore's Law

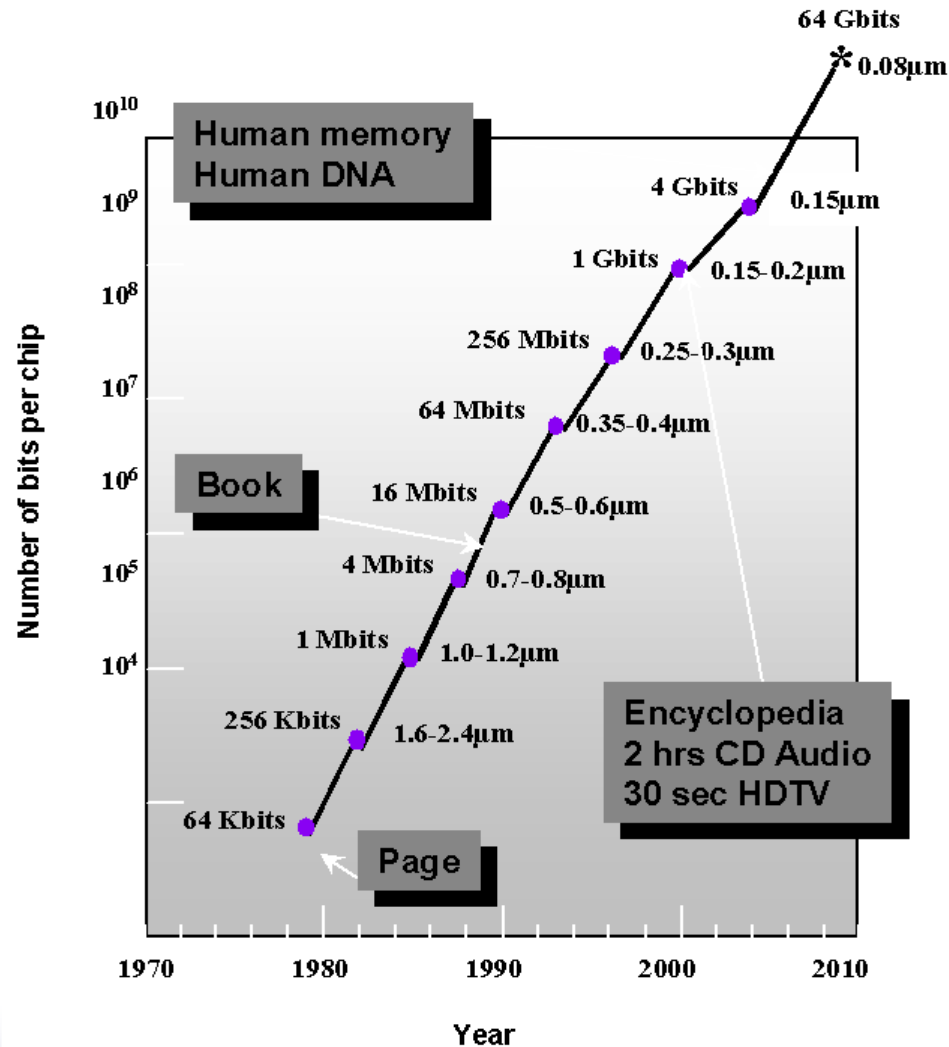
- In 1965, Gordon Moore (co-founder of Intel) noted that the number of transistors on a chip doubled every 18 to 24 months
- He made a prediction that semiconductor technology will double its effectiveness every 18 (24) months

Moore's Law



Electronics, April 19, 1965.

Evolution in Complexity

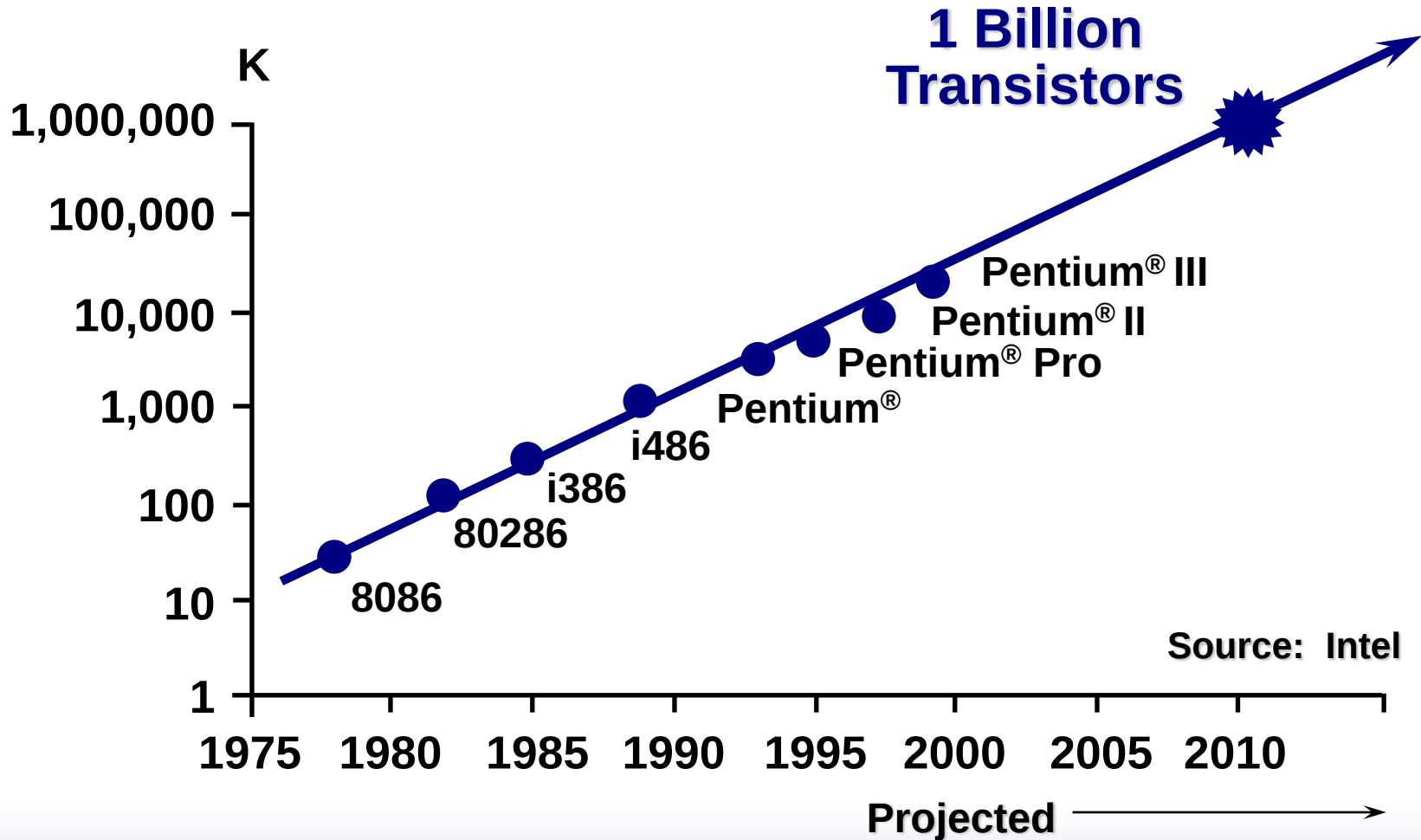


IC Classification

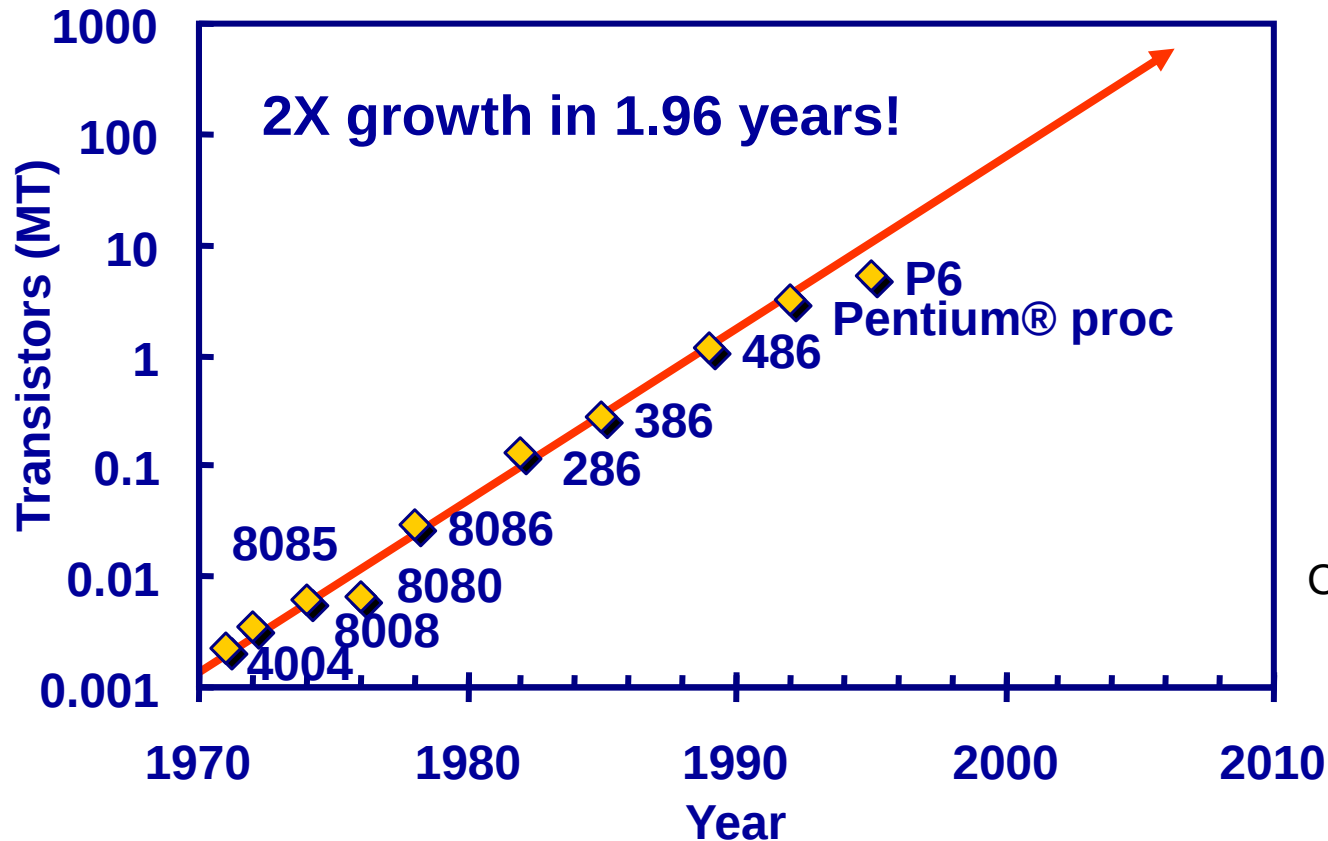
- ❑ **Circuit size** (transistor count)
- ❑ **Circuit technology** (BJT, BiCMOS, NMOS, CMOS)
- ❑ **Design style**
 - standard cell
 - gate array
 - custom
- ❑ **Size classification** (historical)

▪ <100	SSI	1963
▪ 100-3000	MSI	1970
▪ 3000-30,000	LSI	1975
▪ 30,000-1,000,000	VLSI	1980
▪ >1,000,000	ULSI	1990
▪ >1 billion	GSI	2010

Transistor Counts



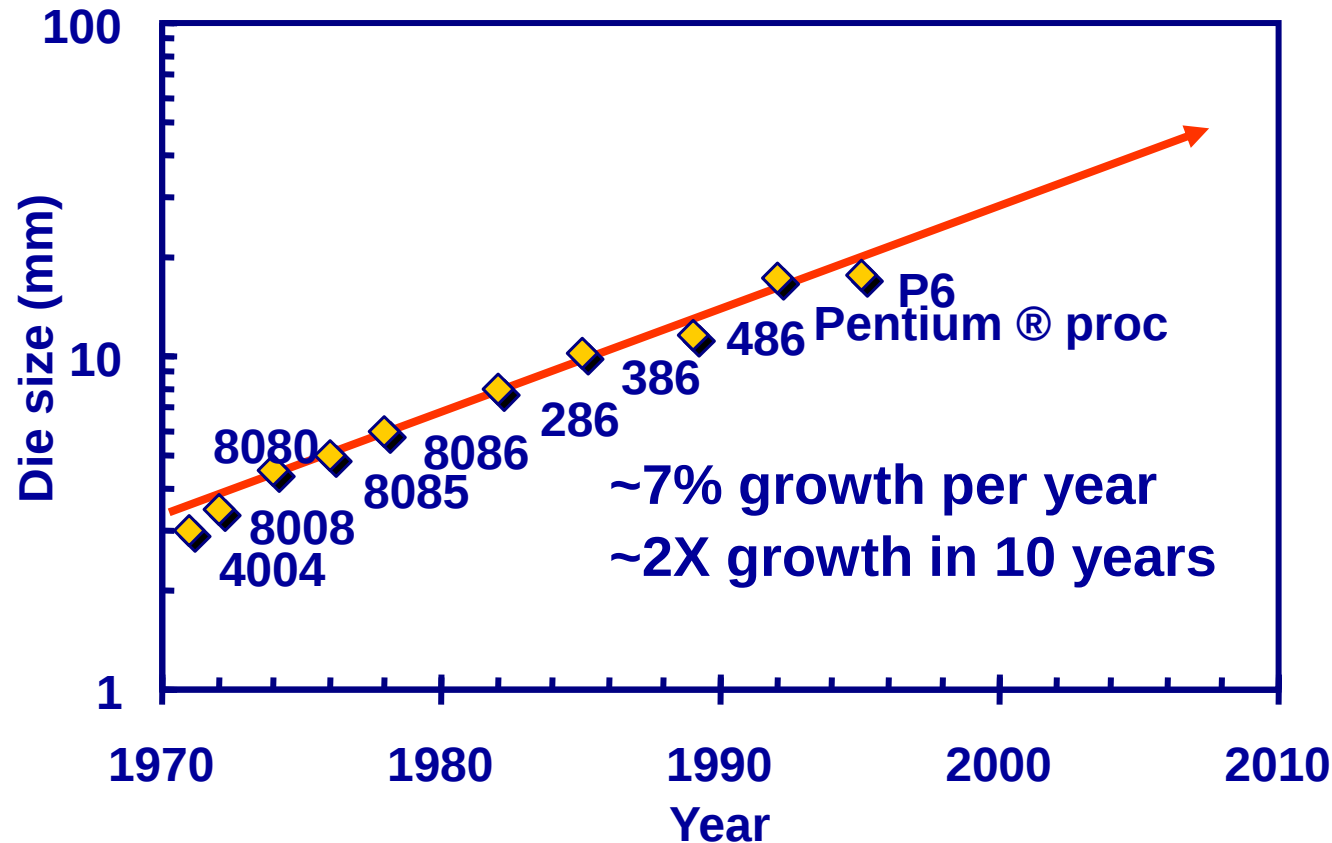
Moore's Law in Microprocessors



Courtesy, Intel

Transistors on Lead Microprocessors double every 2 years

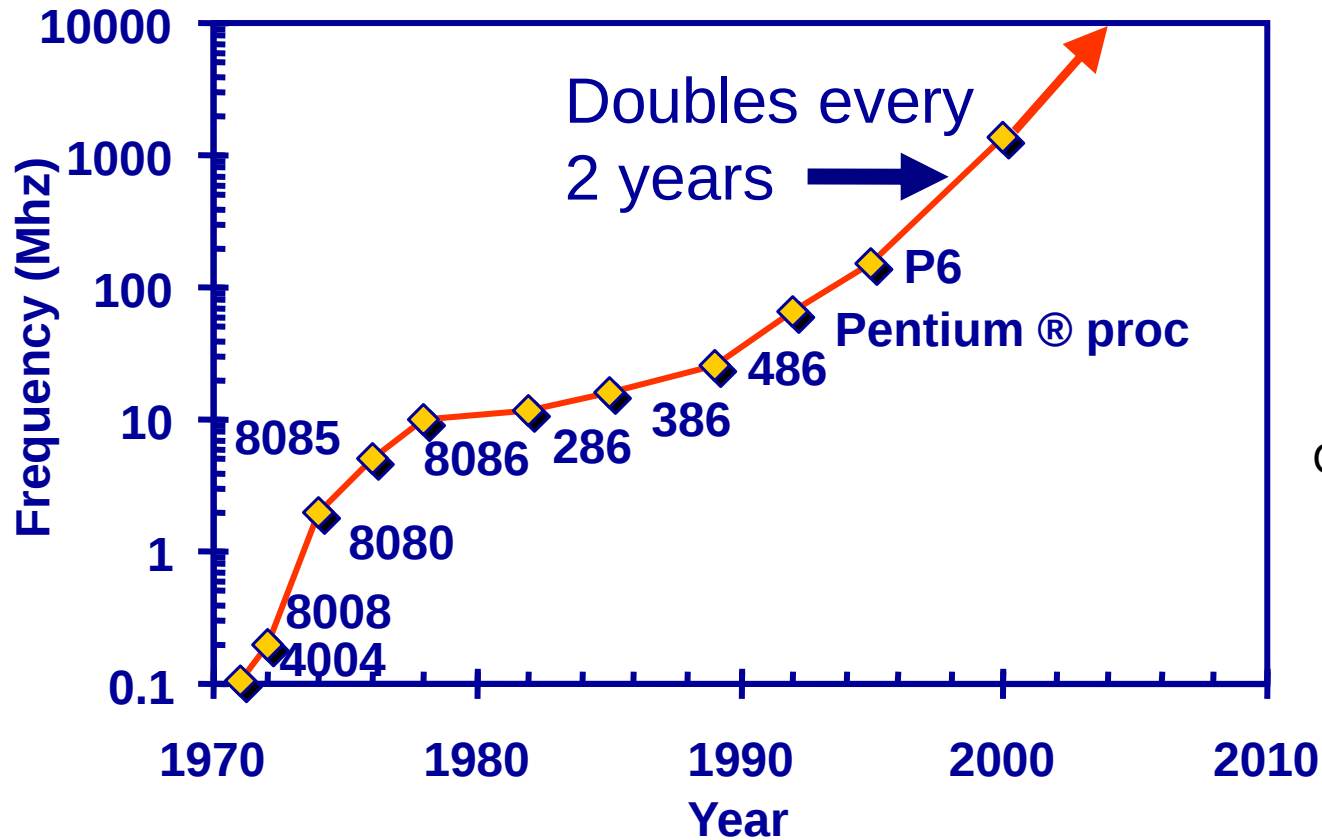
Die Size Growth



Courtesy, Intel

Die size grows by 14% to satisfy Moore's Law

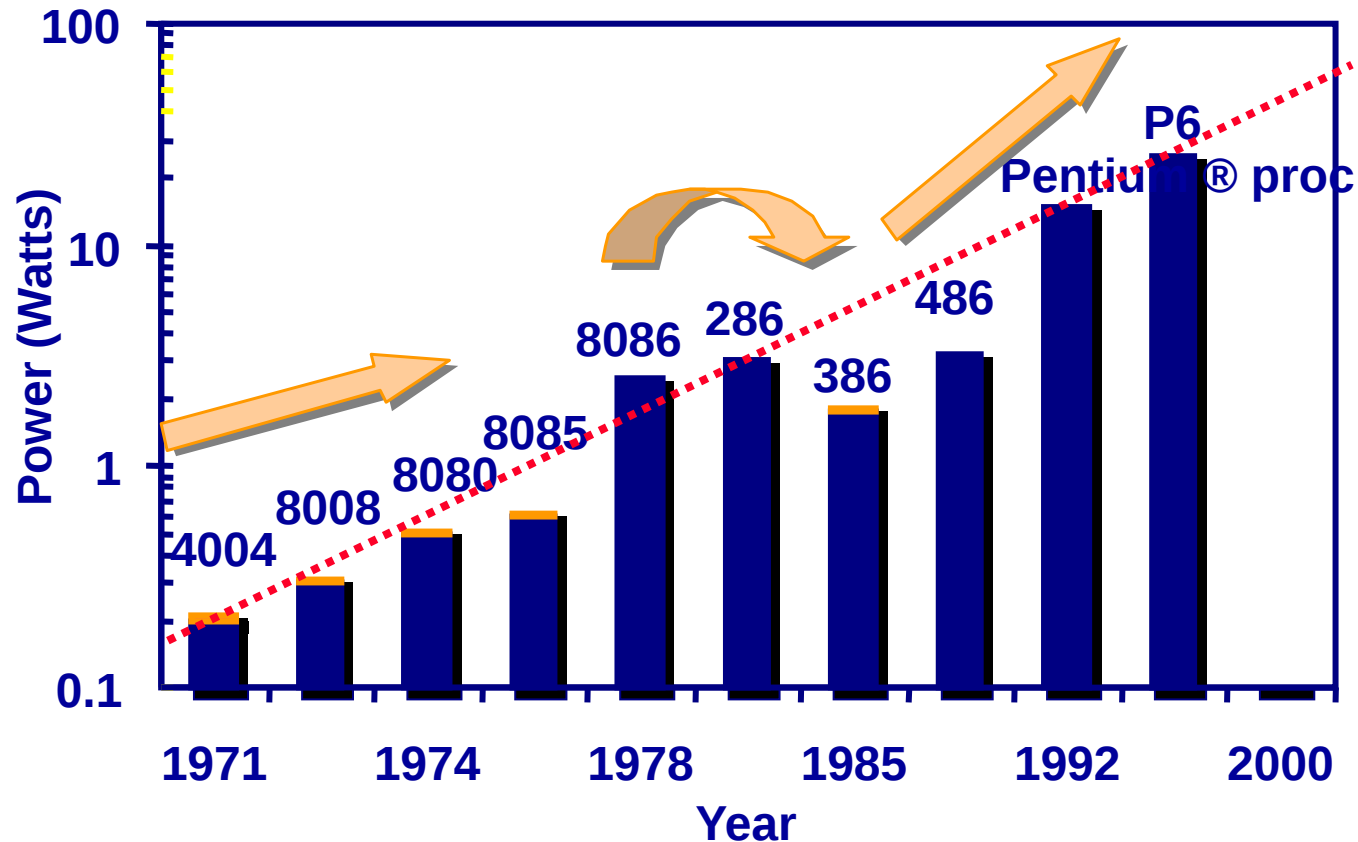
Frequency



Courtesy, Intel

Lead Microprocessors frequency doubles every 2 years

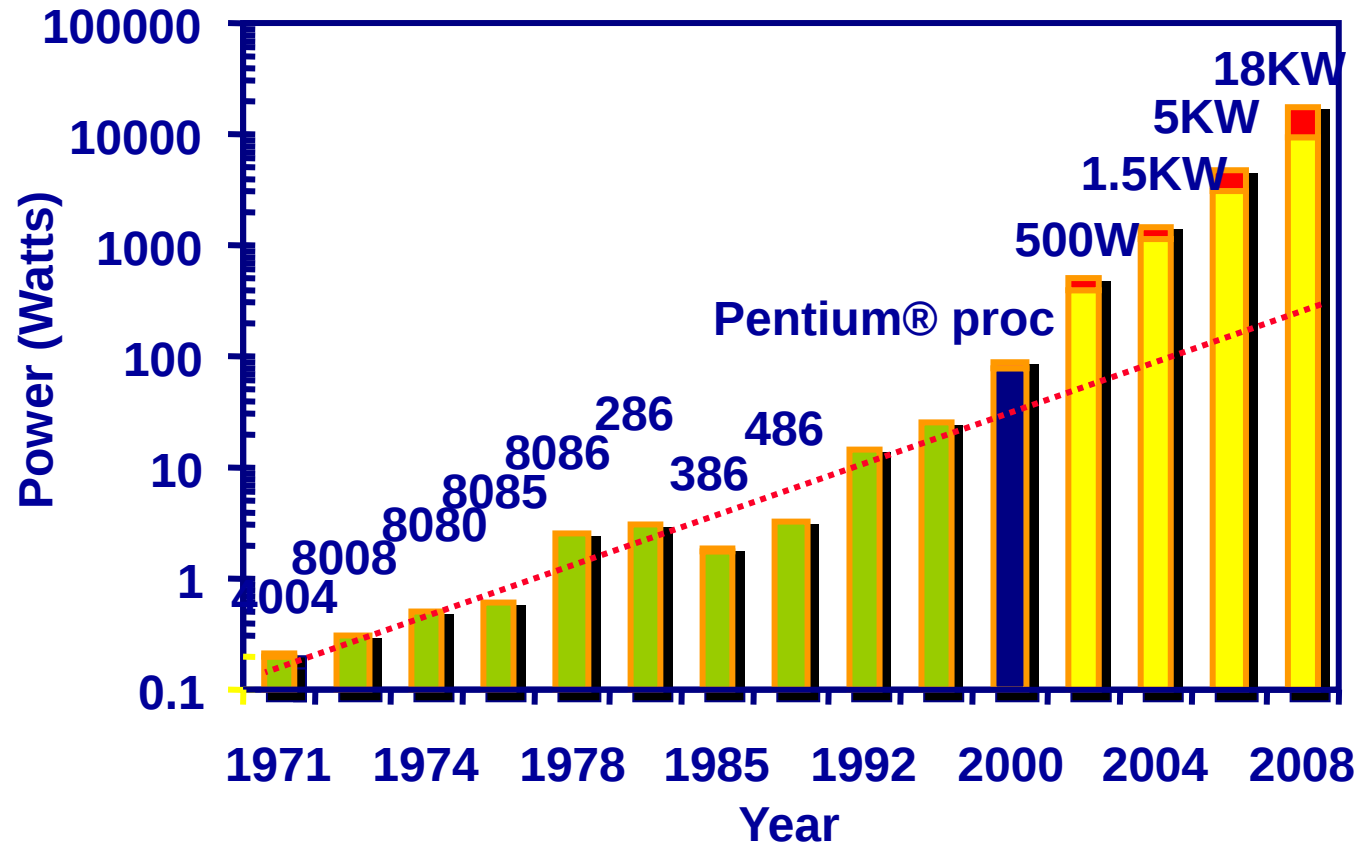
Power Dissipation



Courtesy, Intel

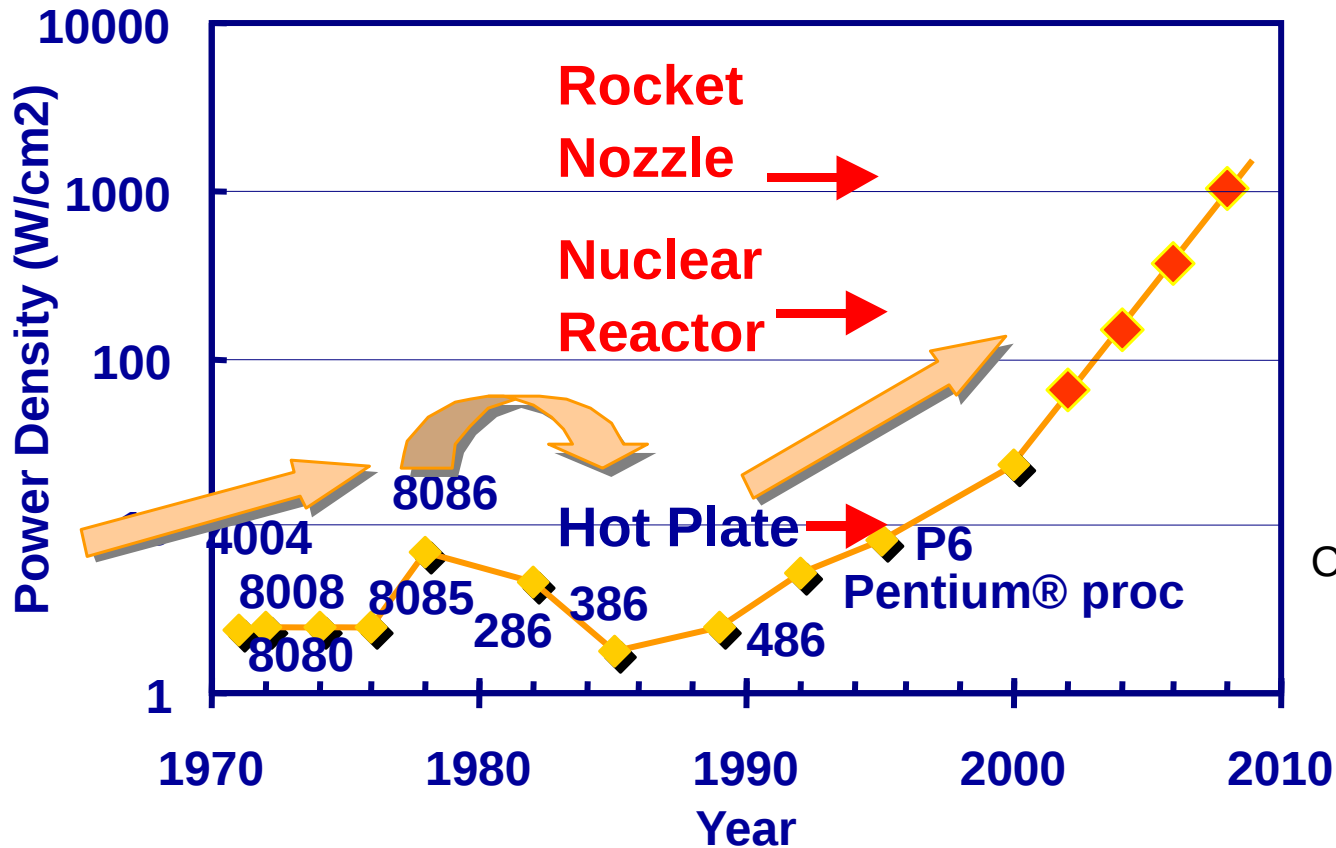
Lead Microprocessor power continues to increase

Power is a major problem....



Power delivery and dissipation will be prohibitive

Power density



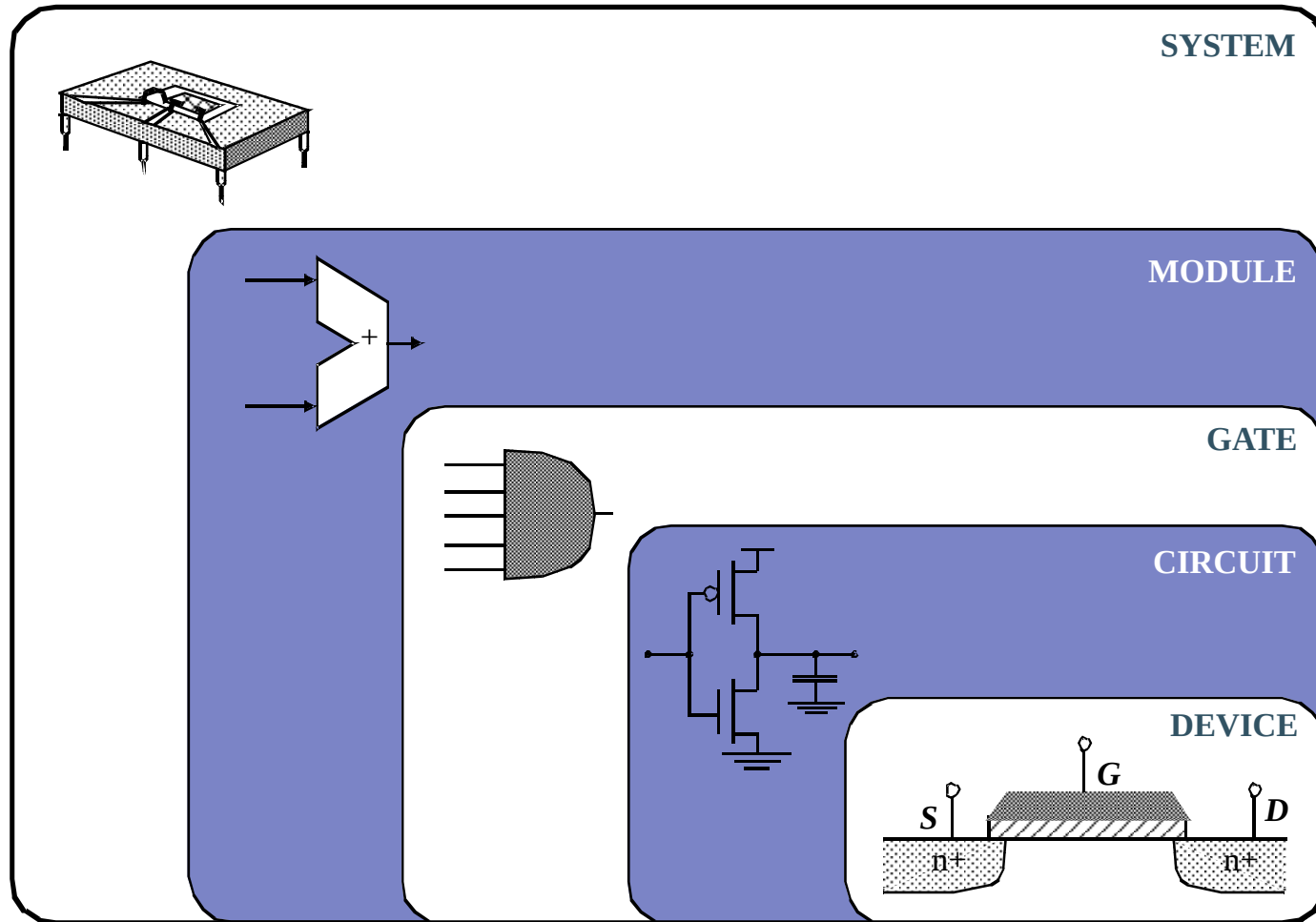
Courtesy, Intel

Power density too high to keep junctions at low temp

Why Scaling?

- ❑ Technology shrinks by 0.7/generation
- ❑ With every generation can integrate 2x more functions per chip; chip cost does not increase significantly (**Dennard's (IBM) scaling law—transistors become faster, consume less power and become cheaper**)
- ❑ Cost of a function decreases by 2x
- ❑ But ...
 - How to design chips with more and more functions?
 - Design engineering population does not double every two years...
- ❑ Hence, a need for more efficient design methods
 - Exploit different levels of abstraction

Design Abstraction Levels



Silicon and Dopant Atoms

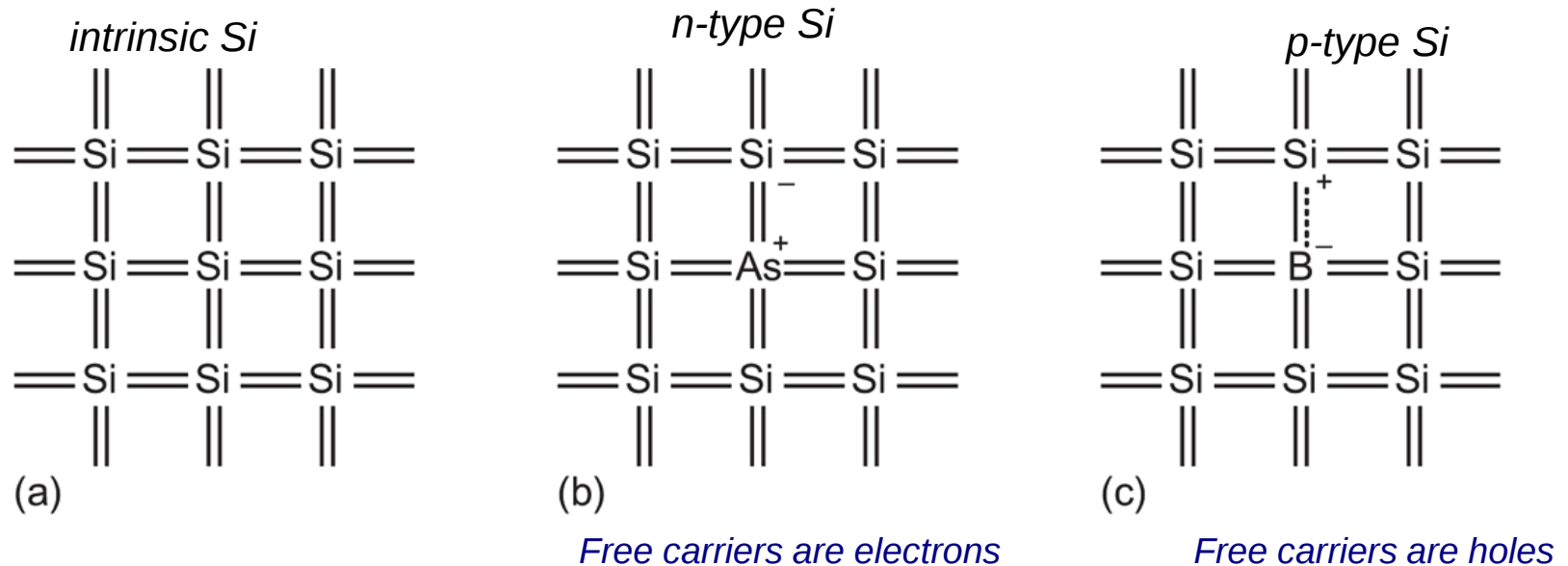
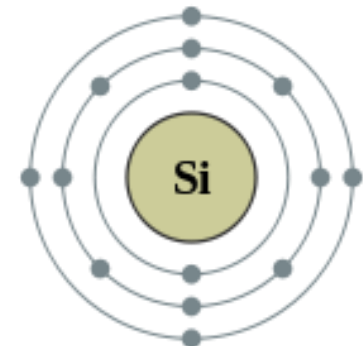


FIG 1.6 Silicon lattice and dopant atoms

Atomic number of Si: **14**

Eighth most abundant element on earth!!

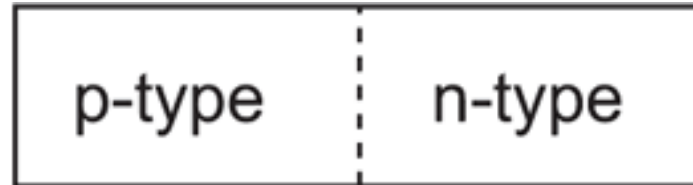
Electronic configuration: $[1s]^2[2s]^2[2p]^6[3s]^2[3p]^2$



4 valence electrons

30

Pn-junction Diode



Forward Bias:

*connect Vdd to p-type
and GND to n-type
(current flows)*

Anode

Cathode



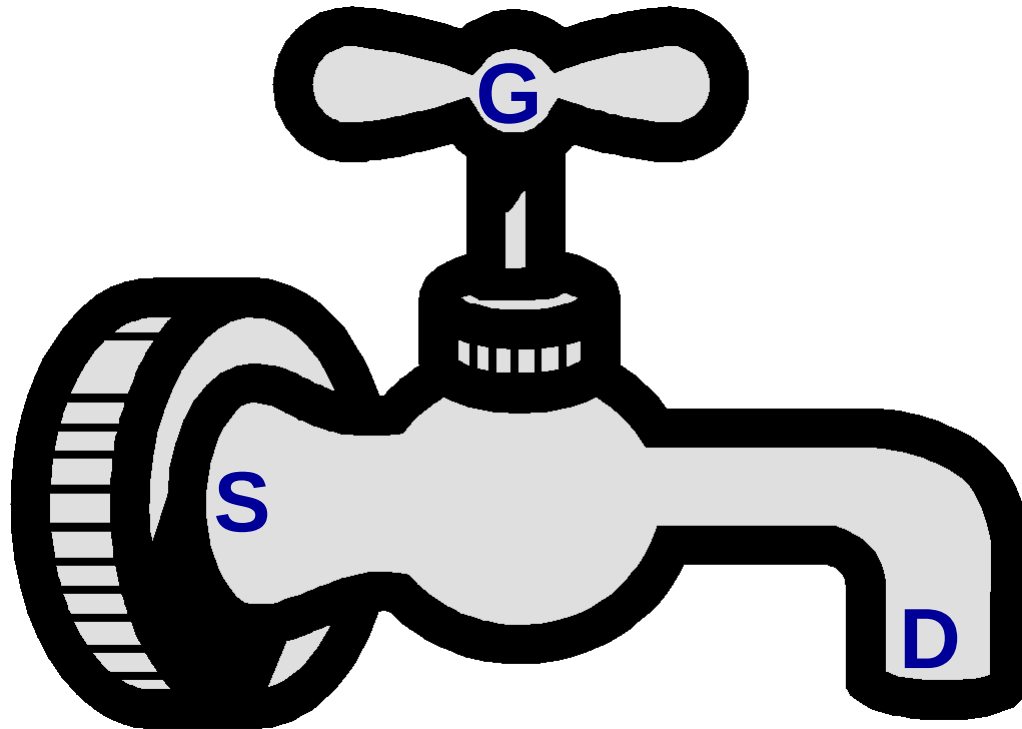
Reverse Bias:

*connect Vdd to n-type
and GND to p-type
(no current)*

FIG 1.7

p-n junction
diode structure
and symbol

MOS Transistor is like a tap....



Think about how you want your tap to function....

MOS (Metal-Oxide-Semiconductor) Transistor

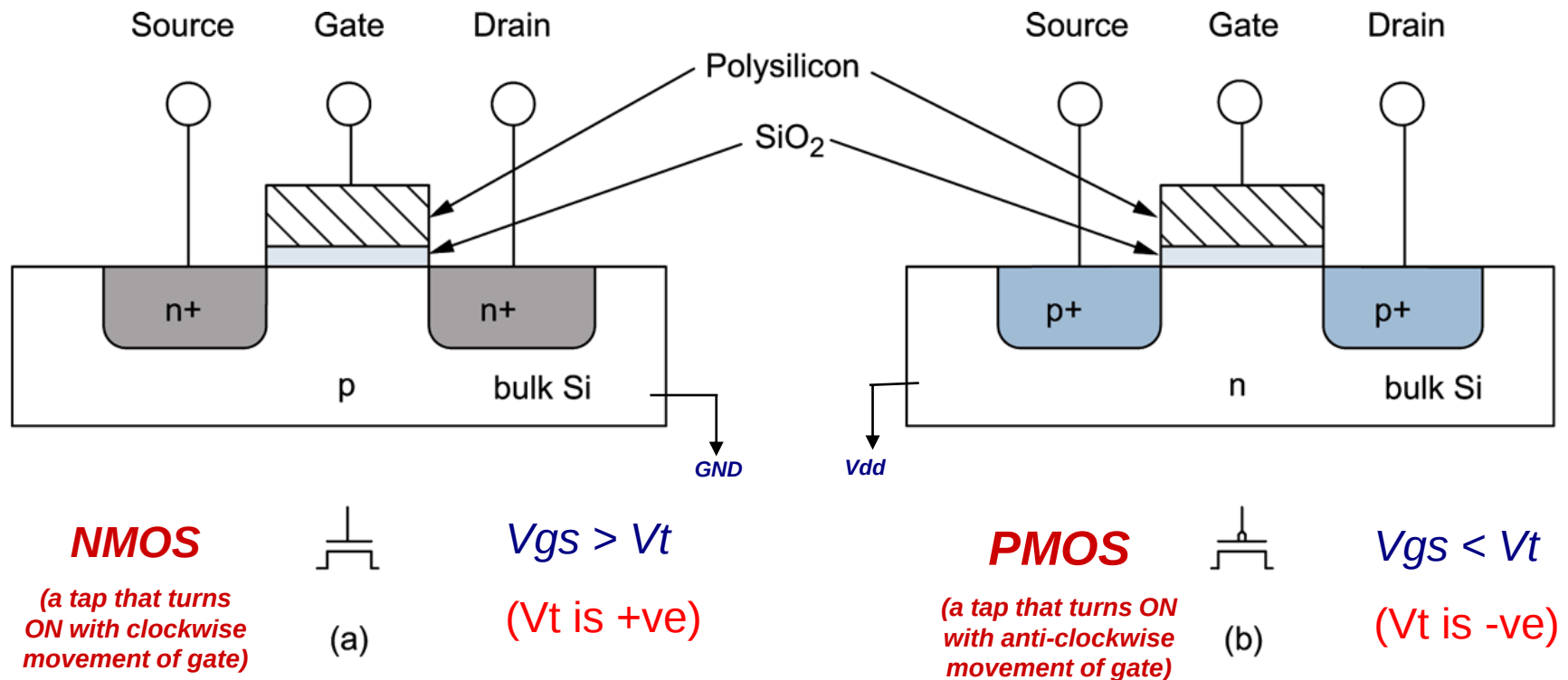


FIG 1.8 nMOS transistor (a) and pMOS transistor (b)

Gate controls the flow of charge from source to drain.....

V_t is the minimum voltage (threshold voltage) required to turn ON transistors

MOS Transistor as a Switch

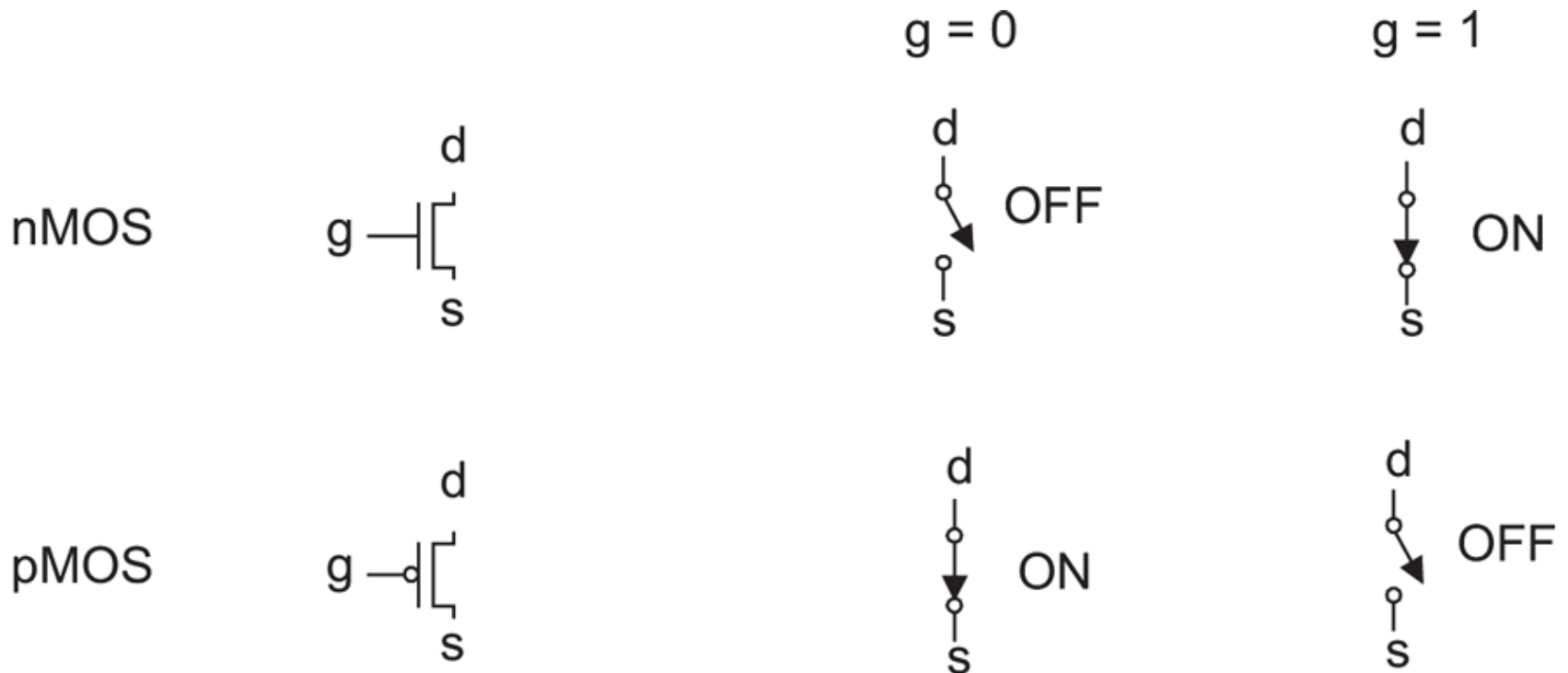
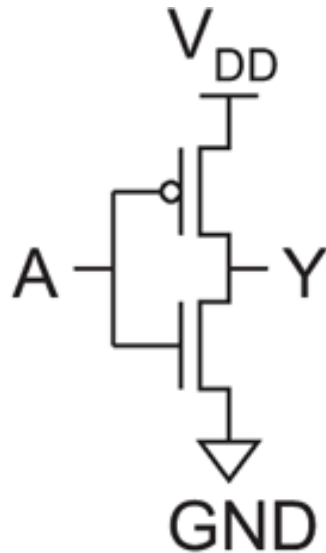


FIG 1.9 Transistor symbols and switch-level models

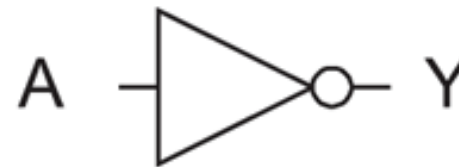
Inverter (NOT Gate)

Table 1.1 Inverter truth table	
A	Y
0	1
1	0

Transistor Level Implementation



(a)



(b)

FIG 1.10 Inverter schematic (a) and symbol (b) $Y = \overline{A}$

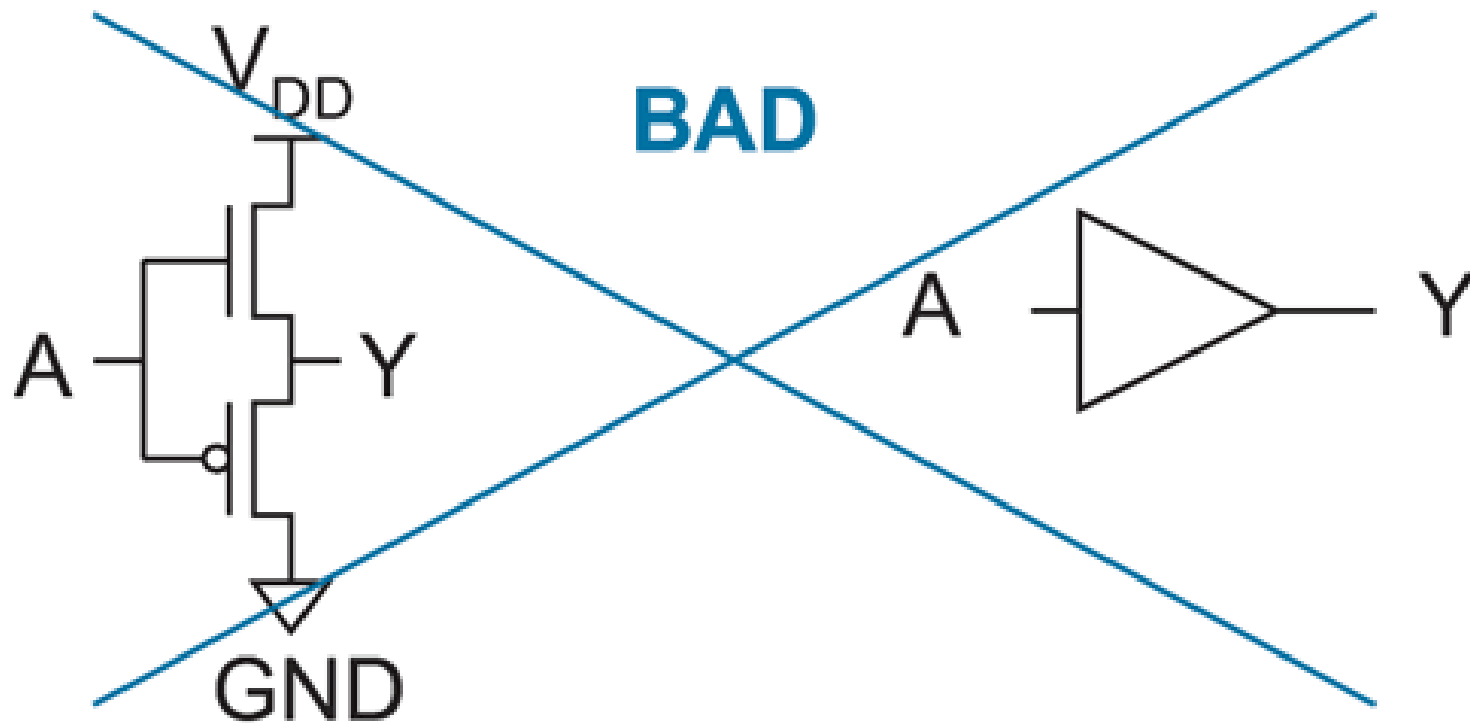
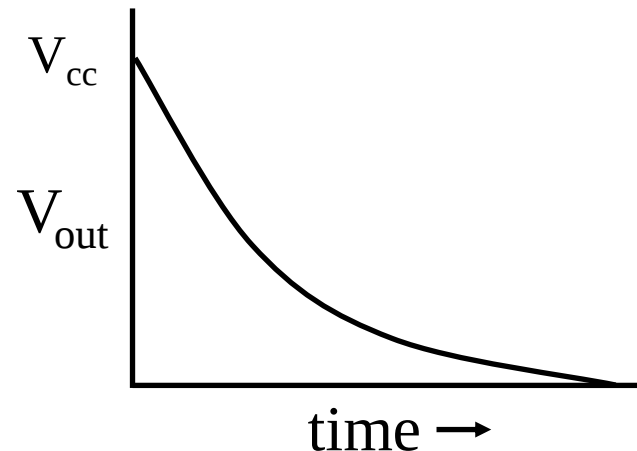
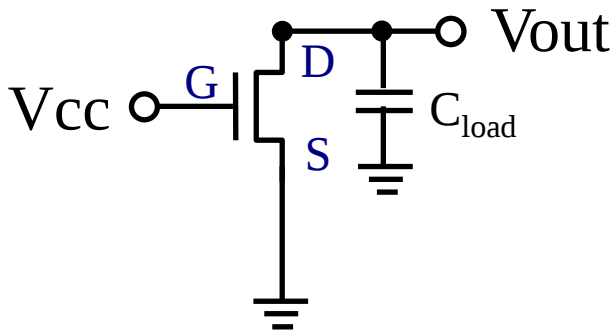


FIG 1.21 Bad noninverting buffer

MOS voltage levels

Case 1: NMOS discharges capacitor

- Initially: $V_{out} = V_{cc}$ (capacitor fully charged)
- V_{GS} of NMOS = V_{cc}
- What is final V_{out} ?

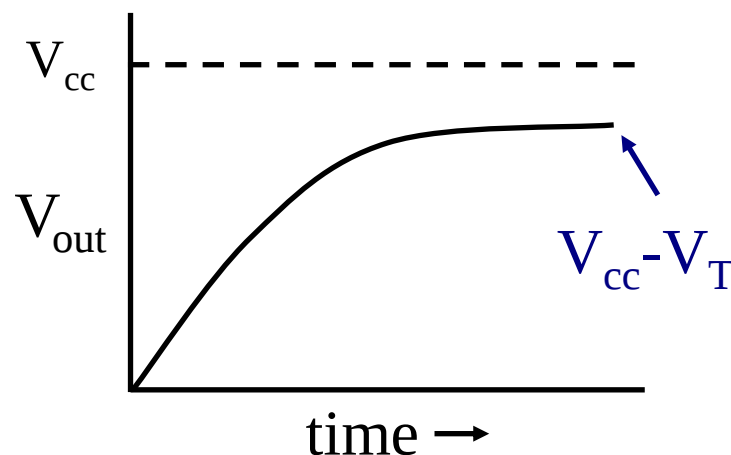
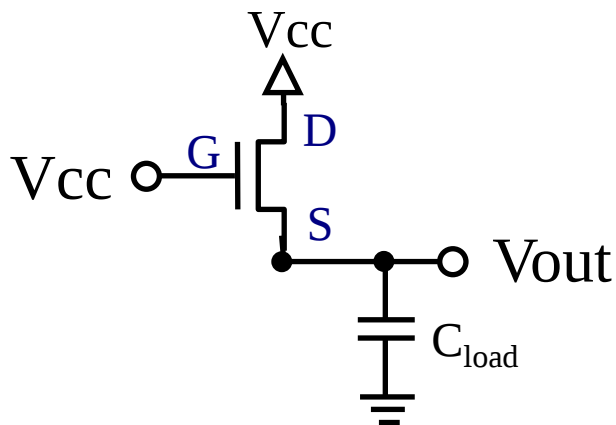


- NMOS remains on since $V_{GS} > V_T$
- Final output voltage $V_{out} = 0\text{ V}$
 - **Value at source (=0) is transferred to the drain (output)....completely**

MOS voltage levels

Case 2: NMOS charges capacitor

- Initially: $V_{out} = 0$
- Initial V_{GS} of NMOS = V_{cc}
- What is final V_{out} ?

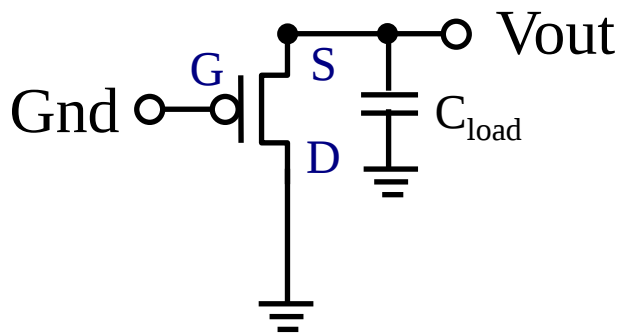


- NMOS remains on until $V_{GS} = V_T$
- Final output voltage $V_{out} = V_{cc} - V_T$
 - **Value at drain (=1) not transferred completely to the source (output)...**

MOS voltage levels

Repeat for PMOS:

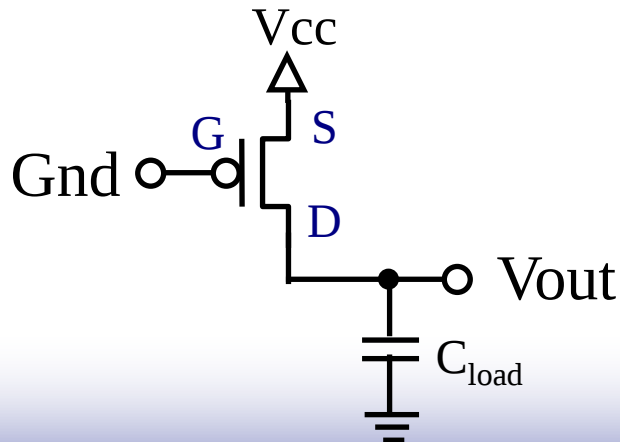
□ Case 1: PMOS discharging capacitor



- PMOS on until $V_{GS} = -V_T$
- $V_{out} = |V_T|$

Value at drain (=0) is not transferred completely to the source (output)....

□ Case 2: PMOS charging capacitor



- PMOS always on ($V_{GS} = -V_{CC}$)
- $V_{out} = V_{CC}$

Value at source (=1) is transferred to the drain (output)....completely